

# XN0431600L Datasheet



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DiGi Electronics Part Number XN0431600L-DG

Manufacturer Panasonic Electronic Components

Manufacturer Product Number XN0431600L

Description TRANS NPN/PNP PREBIAS 0.3W MINI6

Detailed Description Pre-Biased Bipolar Transistor (BJT) 1 NPN, 1 PNP - P re-Biased (Dual) 50V 100mA 150MHz, 80MHz 300m

W Surface Mount MINI6-G1



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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## **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
XN0431600L	Panasonic Electronic Components
Series:	Product Status:
	Obsolete
Transistor Type:	Current - Collector (Ic) (Max):
1 NPN, 1 PNP - Pre-Biased (Dual)	100mA
Voltage - Collector Emitter Breakdown (Max):	Resistor - Base (R1):
50V	4.7kOhms
Resistor - Emitter Base (R2):	DC Current Gain (hFE) (Min) @ lc, Vce:
	160 @ 5mA, 10V
Vce Saturation (Max) @ lb, lc:	Current - Collector Cutoff (Max):
250mV @ 300μA, 10mA	500nA
Frequency - Transition:	Power - Max:
150MHz, 80MHz	300mW
Mounting Type:	Package / Case:
Surface Mount	SOT-23-6
Supplier Device Package:	Base Product Number:
MINI6-G1	XN0431

## **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	ECCN:
1 (Unlimited)	EAR99
HTSUS:	
8541.21.0075	

# XN04316 (XN4316)

## Silicon NPN epitaxial planar type (Tr1) Silicon PNP epitaxial planar type (Tr2)

For switching/digital circuits

#### ■ Features

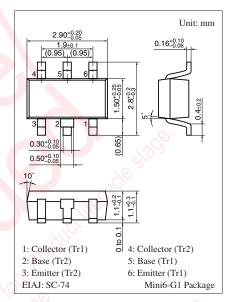
- Two elements incorporated into one package (Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half

## ■ Basic Part Number

• UNR2216 (UN2216) + UNR2116 (UN2116)

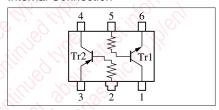
## ■ Absolute Maximum Ratings T<sub>a</sub> = 25°C

Parameter		Symbol	Rating	Unit
Tr1	Collector-base voltage	V <sub>CBO</sub>	50	V
	(Emitter open)			
	Collector-emitter voltage	V <sub>CEO</sub>	50	V
	(Base open)			
	Collector current	$I_{C}$	100	mA
Tr2	Collector-base voltage	$V_{CBO}$	-50	V
	(Emitter open)			
	Collector-emitter voltage	V <sub>CEO</sub>	-50	V
	(Base open)		76	
	Collector current	$I_{C}$	-100	mA
Overall	Total power dissipation	$P_{T}$	300	mW
	Junction temperature	T <sub>j</sub>	150	°C
	Storage temperature	$T_{stg}$	-55 to +150	°C



Marking Symbol: 7U

### Internal Connection



Note) The part number in the parenthesis shows conventional part number.

## ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

#### • Tr1

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 10 \ \mu A, I_E = 0$	50			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 2 \text{ mA}, I_B = 0$	50			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 50 \text{ V}, I_E = 0$			0.1	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = 50 \text{ V}, I_{B} = 0$			0.5	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 6 \text{ V}, I_C = 0$			0.01	mA
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	160		460	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA}$			0.25	V
Output voltage high-level	V <sub>OH</sub>	$V_{CC} = 5 \text{ V}, V_B = 0.5 \text{ V}, R_L = 1 \text{ k}\Omega$	4.9			V
Output voltage low-level	V <sub>OL</sub>	$V_{CC} = 5 \text{ V}, V_B = 2.5 \text{ V}, R_L = 1 \text{ k}\Omega$			0.2	V
Input resistance	R <sub>1</sub>		-30%	4.7	+30%	kΩ
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

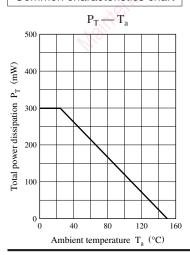
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

### • Tr2

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = -10 \mu\text{A}, I_{\rm E} = 0$	-50			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = -2 \text{ mA}, I_B = 0$	-50			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = -50 \text{ V}, I_E = 0$			- 0.1	μA
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = -50 \text{ V}, I_B = 0$	7		- 0.5	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = -6 \text{ V}, I_C = 0$	1085		- 0.01	mA
Forward current transfer ratio	$h_{FE}$	$V_{CE} = -10 \text{ V}, I_{C} = -5 \text{ mA}$	160	1	460	<i></i>
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -10 \text{ mA}, I_B = -0.3 \text{ mA}$	,0°	XQ2	- 0.25	V
Output voltage high-level	V <sub>OH</sub>	$V_{CC} = -5 \text{ V}, V_B = -0.5 \text{ V}, R_L = 1 \text{ k}\Omega$	-4.9	). · · · · · · · · · · · · · · · · · · ·	Ċ	V
Output voltage low-level	V <sub>OL</sub>	$V_{CC} = -5 \text{ V}, V_B = -2.5 \text{ V}, R_L = 1 \text{ k}\Omega$	~0 <sub>D</sub>	0/1/2	- 0.2	V
Input resistance	R <sub>1</sub>	On the grantille	-30%	4.7	+30%	kΩ
Transition frequency	$f_T$	$V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$	0	80		MHz

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

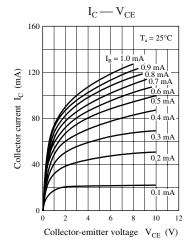
## Common characteristics chart

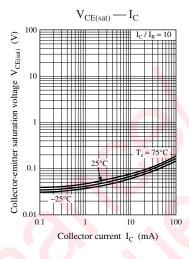


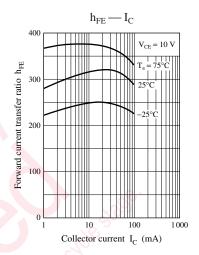
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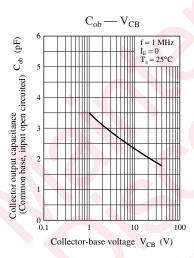
Panasonic XN04316

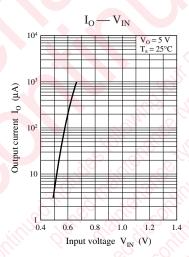
### Characteristics charts of Tr1

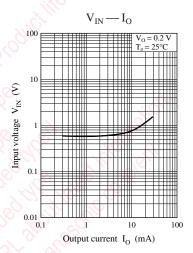






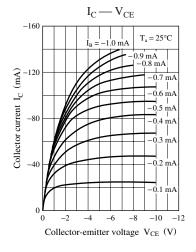


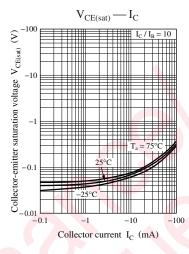


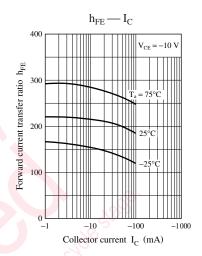


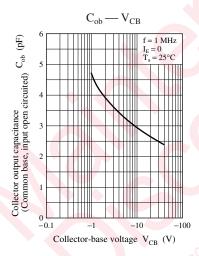
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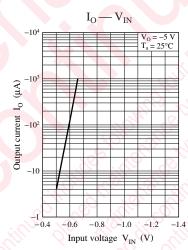
### Characteristics charts of Tr2

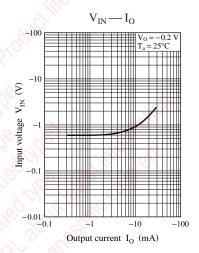












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